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FDMS9620S

Dual N-Channel PowerTrench® MOSFET

Q1: 30V, 16A, 21.5mΩ Q2: 30V, 18A, 13mΩ

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 21.5mΩ at $V_{GS} = 10V$, $I_D = 7.5A$
- Max $r_{DS(on)}$ = 29.5mΩ at $V_{GS} = 4.5V$, $I_D = 6.5A$

Q2: N-Channel

- Max $r_{DS(on)}$ = 13mΩ at $V_{GS} = 10V$, $I_D = 10A$
- Max $r_{DS(on)}$ = 17mΩ at $V_{GS} = 4.5V$, $I_D = 8.5A$
- Low Q_g high side MOSFET
- Low $r_{DS(on)}$ low side MOSFET
- Thermally efficient dual Power 56 package
- Pinout optimized for simple PCB design
- RoHS Compliant



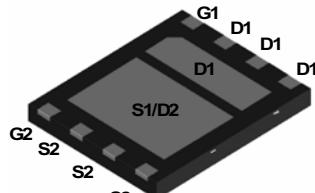
General Description

This device includes two specialized MOSFETs in a unique dual Power 56 package. It is designed to provide an optimal Synchronous Buck power stage in terms of efficiency and PCB utilization. The low switching loss "High Side" MOSFET is complemented by a Low Conduction Loss "Low Side" SyncFET.

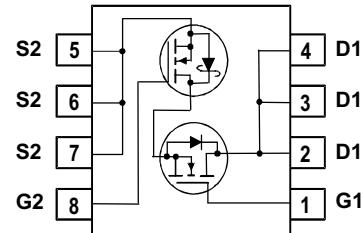
Applications

Synchronous Buck Converter for:

- Notebook System Power
- General Purpose Point of Load



Power 56



MOSFET Maximum Ratings $T_A = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Q1	Q2	Units
V_{DS}	Drain to Source Voltage	30	30	V
V_{GS}	Gate to Source Voltage	± 20	± 20	V
I_D	Drain Current -Continuous $T_C = 25^\circ C$	16	18	A
	-Continuous $T_A = 25^\circ C$ (Note 1a)	7.5	10	
	-Pulsed	60	60	
P_D	Power Dissipation for Single Operation $T_A = 25^\circ C$ (Note 1a)	2.5		W
	$T_A = 25^\circ C$ (Note 1b)	1		
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150		°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	8.2	3.1	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1b)	120		

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS9620S	FDMS9620S	Power 56	13"	12mm	3000 units

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Type	Min	Typ	Max	Units
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$ $I_D = 1\text{mA}, V_{GS} = 0\text{V}$	Q1 Q2	30 30			V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu\text{A}, \text{referenced to } 25^\circ\text{C}$ $I_D = 1\text{mA}, \text{referenced to } 25^\circ\text{C}$	Q1 Q2		23 23		mV°C
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$	Q1 Q2			1 500	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$	Q1 Q2			± 100 ± 100	nA

On Characteristics

$V_{GS(\text{th})}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$ $V_{GS} = V_{DS}, I_D = 1\text{mA}$	Q1 Q2	1 1	1.6 1.6	3 3	V
$\frac{\Delta V_{GS(\text{th})}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu\text{A}, \text{referenced to } 25^\circ\text{C}$ $I_D = 1\text{mA}, \text{referenced to } 25^\circ\text{C}$	Q1 Q2		-4 -4		mV°C
$r_{DS(\text{on})}$	Drain to Source On Resistance	$V_{GS} = 10\text{V}, I_D = 7.5\text{A}$ $V_{GS} = 4.5\text{V}, I_D = 6.5\text{A}$ $V_{GS} = 10\text{V}, I_D = 7.5\text{A}, T_J = 125^\circ\text{C}$	Q1		18 23 25	21.5 29.5 32	$\text{m}\Omega$
		$V_{GS} = 10\text{V}, I_D = 10\text{A}$ $V_{GS} = 4.5\text{V}, I_D = 8.5\text{A}$ $V_{GS} = 10\text{V}, I_D = 10\text{A}, T_J = 125^\circ\text{C}$	Q2		9 13 14	13 17 22	
g_{FS}	Forward Transconductance	$V_{DD} = 10\text{V}, I_D = 7.5\text{A}$ $V_{DD} = 10\text{V}, I_D = 10\text{A}$	Q1 Q2		25 27		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	Q1 Q2		500 700	665 935	pF
C_{oss}	Output Capacitance		Q1 Q2		100 500	135 665	pF
C_{rss}	Reverse Transfer Capacitance		Q1 Q2		65 100	100 150	pF
R_g	Gate Resistance	$f = 1\text{MHz}$	Q1 Q2		0.9 1.8		Ω

Switching Characteristics

$t_{d(\text{on})}$	Turn-On Delay Time	$V_{DD} = 15\text{V}, I_D = 1\text{A}, V_{GS} = 10\text{V}, R_{\text{GEN}} = 6\Omega$	Q1 Q2		11 15	20 27	ns
t_r	Rise Time		Q1 Q2		7 13	14 24	ns
$t_{d(\text{off})}$	Turn-Off Delay Time		Q1 Q2		23 27	37 44	ns
t_f	Fall Time		Q1 Q2		2.3 7	10 14	ns
Q_g	Total Gate Charge	$Q1$ $V_{DD} = 15\text{V}, V_{GS} = 10\text{V}, I_D = 7.5\text{A}$ $Q2$ $V_{DD} = 15\text{V}, V_{GS} = 10\text{V}, I_D = 10\text{A}$	Q1 Q2		10 18	14 25	nC
Q_{gs}	Gate to Source Gate Charge		Q1 Q2		1.7 2.8		nC
Q_{gd}	Gate to Drain "Miller" Charge		Q1 Q2		2.0 3.6		nC

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Type	Min	Typ	Max	Units
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Drain-Source Diode Characteristics

I_S	Maximum Continuous Drain-Source Diode Forward Current	Q1 Q2			2.1 3.5	A	
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0\text{V}$, $I_S = 2.1\text{A}$ $V_{GS} = 0\text{V}$, $I_S = 3.5\text{A}$ (Note 2)	Q1 Q2		0.7 0.5	1.2 1.0	V
t_{rr}	Reverse Recovery Time	Q1 $I_F = 7.5\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$	Q1 Q2		13 14		ns
		Q2 $I_F = 10\text{A}$, $di/dt = 300\text{A}/\mu\text{s}$	Q1 Q2		4 9		nC

Notes:

1: R_{\thetaJA} is determined with the device mounted on a 1in^2 pad 2 oz copper pad on a 1.5×1.5 in. board of FR-4 material. R_{\thetaJC} is guaranteed by design while R_{\thetaCA} is determined by the user's board design.



a. $50^\circ\text{C}/\text{W}$ when mounted on a 1in^2 pad of 2 oz copper



b. $120^\circ\text{C}/\text{W}$ when mounted on a minimum pad of 2 oz copper

2: Pulse Test: Pulse Width $< 300\mu\text{s}$, Duty cycle $< 2.0\%$.

Typical Characteristics (Q1 N-Channel) $T_J = 25^\circ\text{C}$ unless otherwise noted

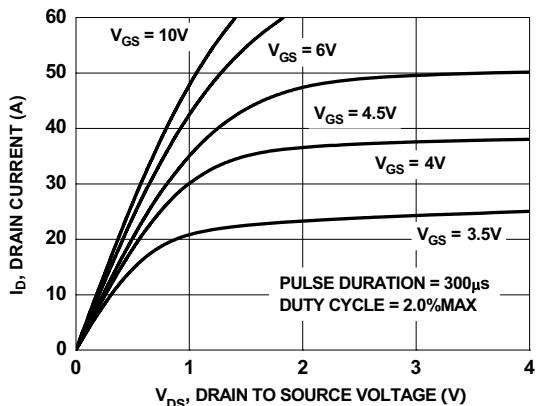


Figure 1. On Region Characteristics

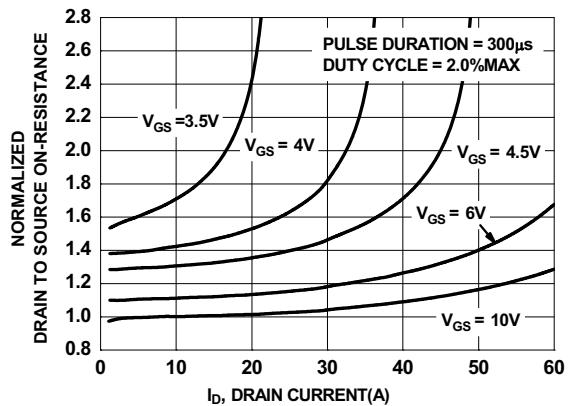


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

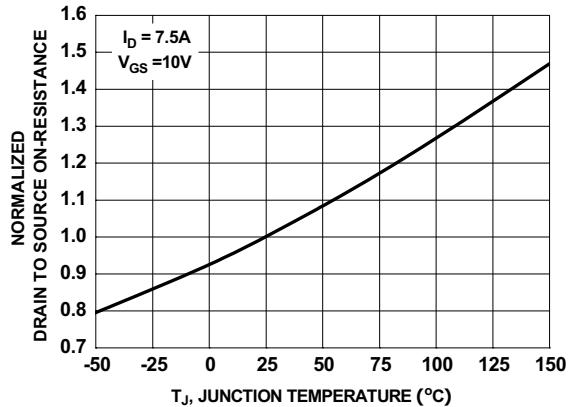


Figure 3. Normalized On Resistance vs Junction Temperature

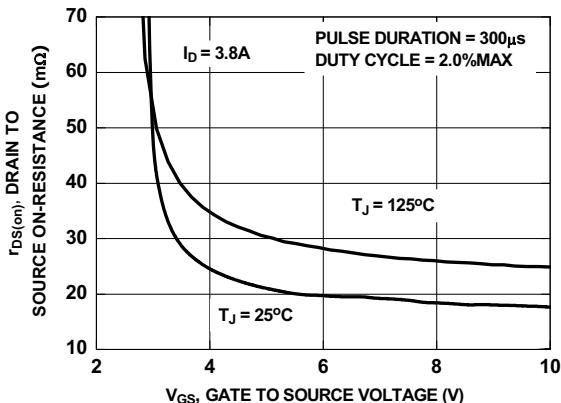


Figure 4. On-Resistance vs Gate to Source Voltage

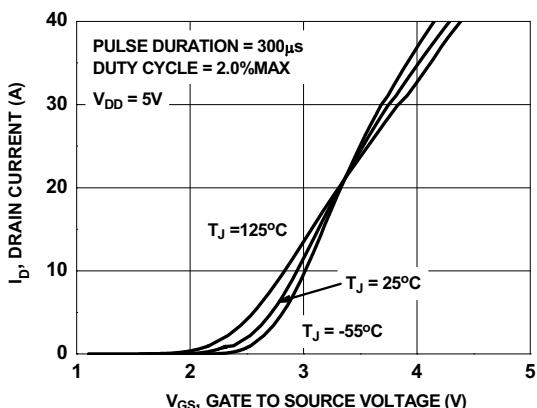


Figure 5. Transfer Characteristics

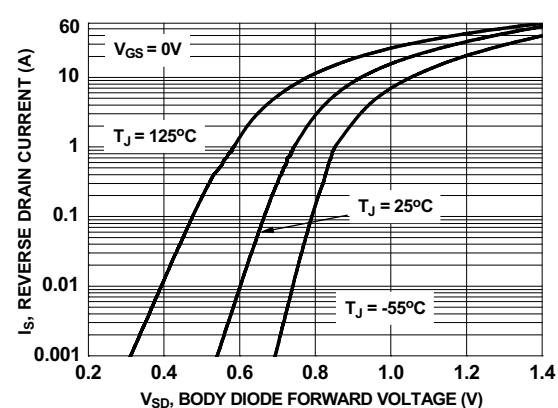


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics (Q1 N-Channel) $T_J = 25^\circ\text{C}$ unless otherwise noted

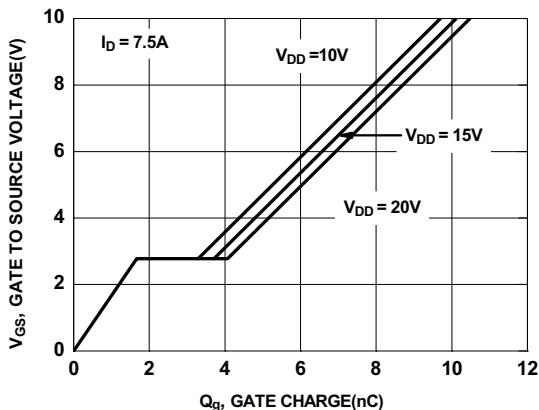


Figure 7. Gate Charge Characteristics

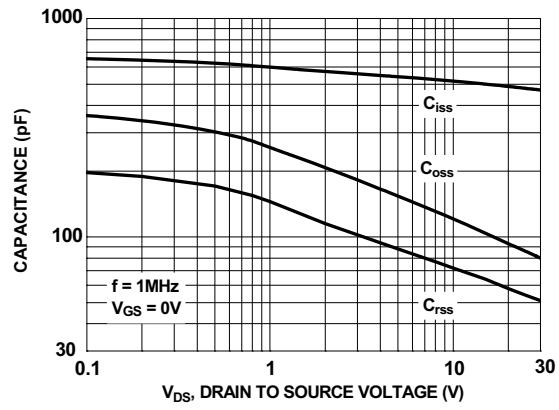


Figure 8. Capacitance vs Drain to Source Voltage

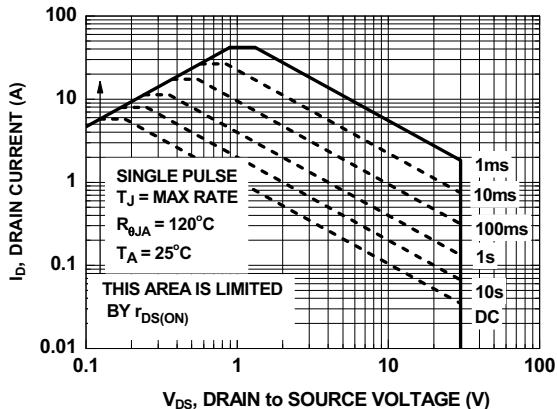


Figure 9. Forward Bias Safe Operating Area

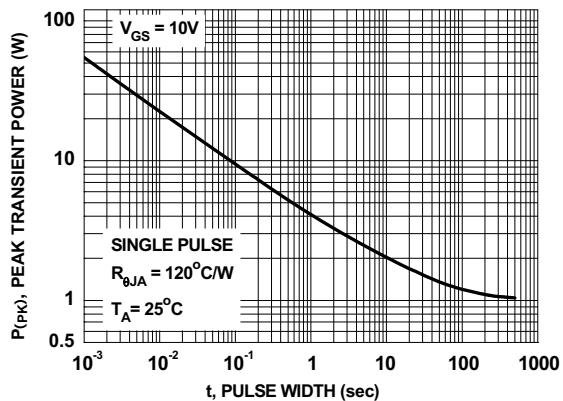


Figure 10. Single Pulse Maximum Power Dissipation

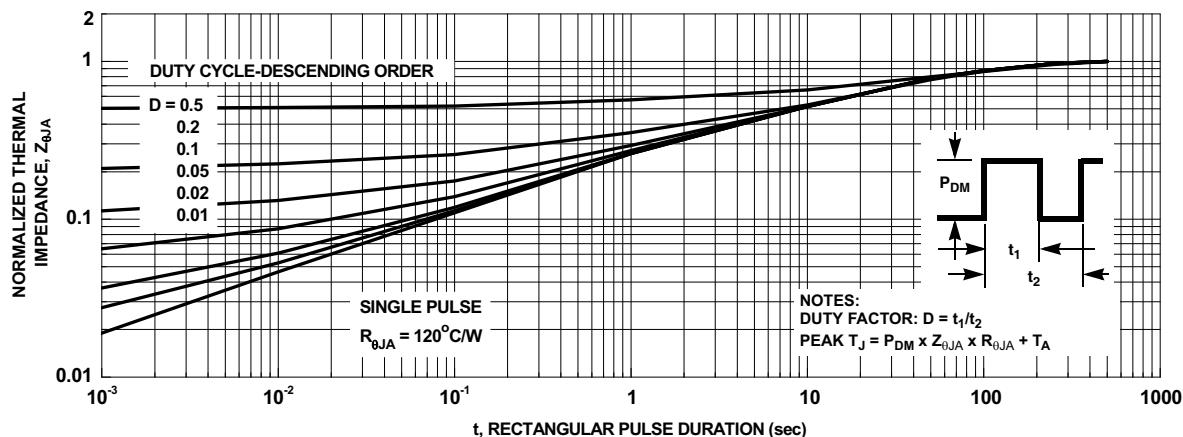


Figure 11. Transient Thermal Response Curve

Typical Characteristics (Q2 SyncFET)

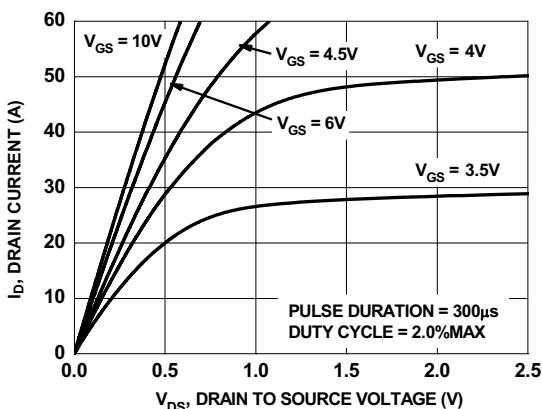


Figure 12. On-Region Characteristics

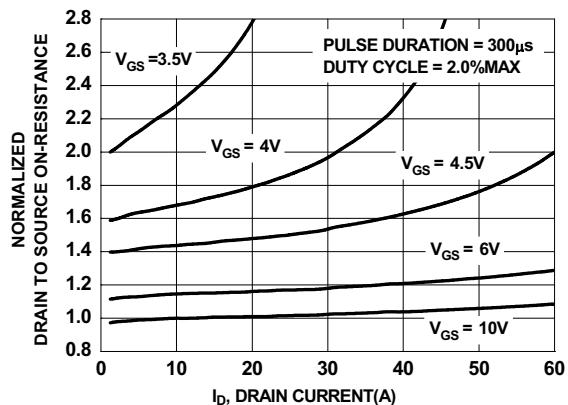


Figure 13. Normalized on-Resistance vs Drain Current and Gate Voltage

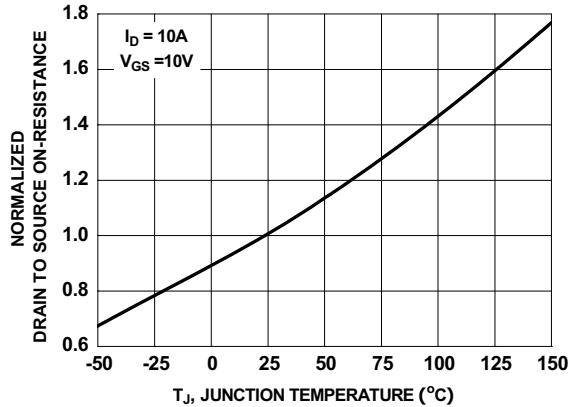


Figure 14. Normalized On-Resistance vs Junction Temperature

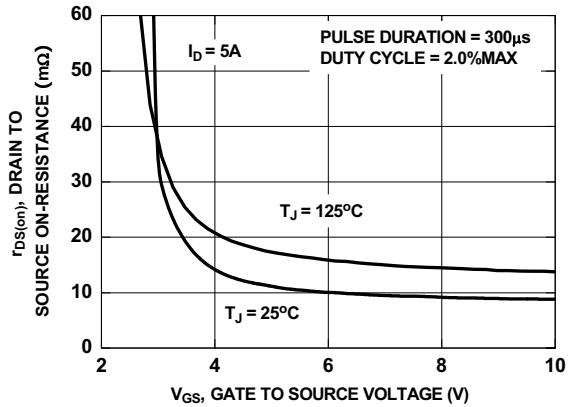


Figure 15. On-Resistance vs Gate to Source Voltage

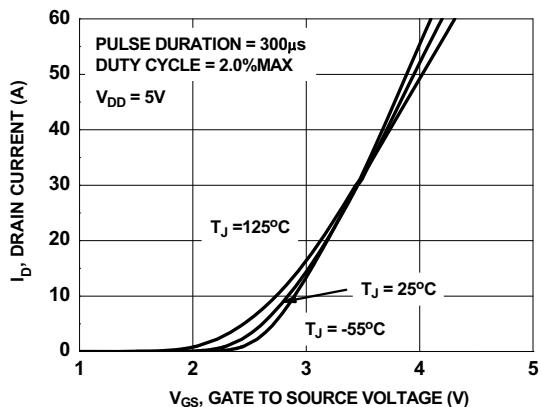


Figure 16. Transfer Characteristics

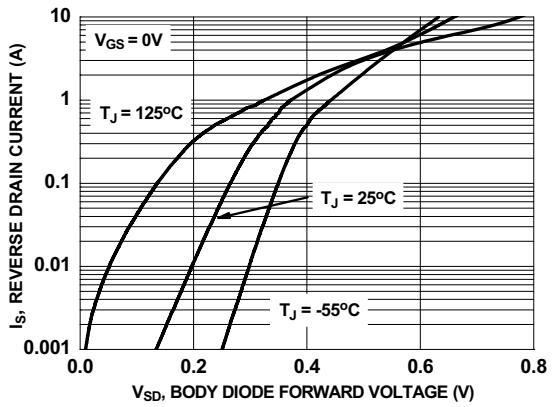


Figure 17. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics

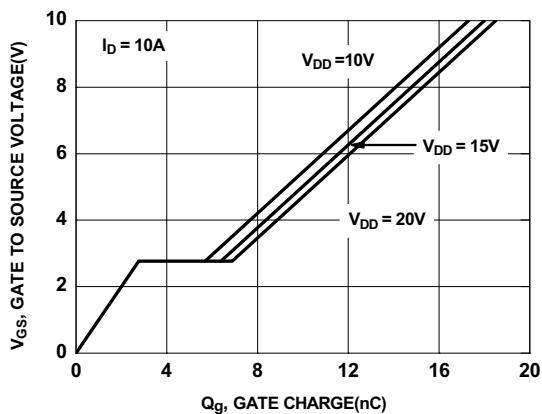


Figure 18. Gate Charge Characteristics

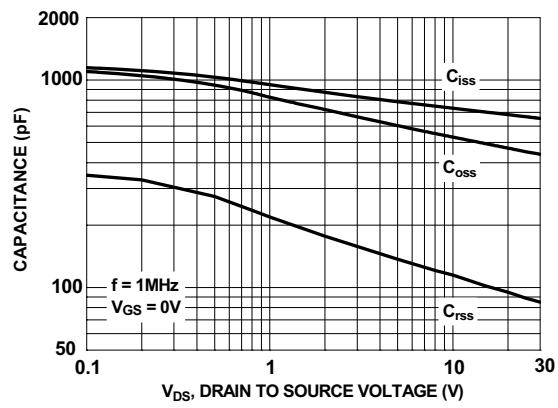
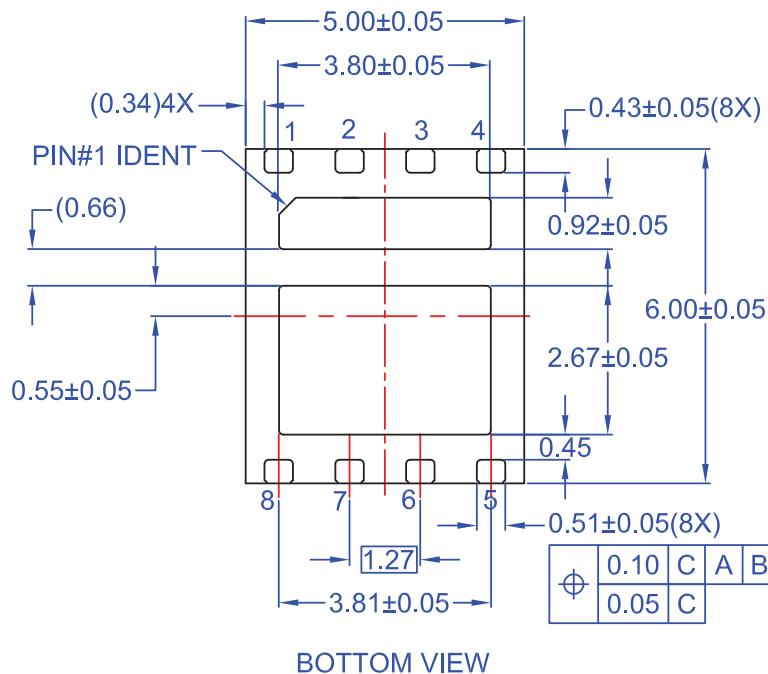
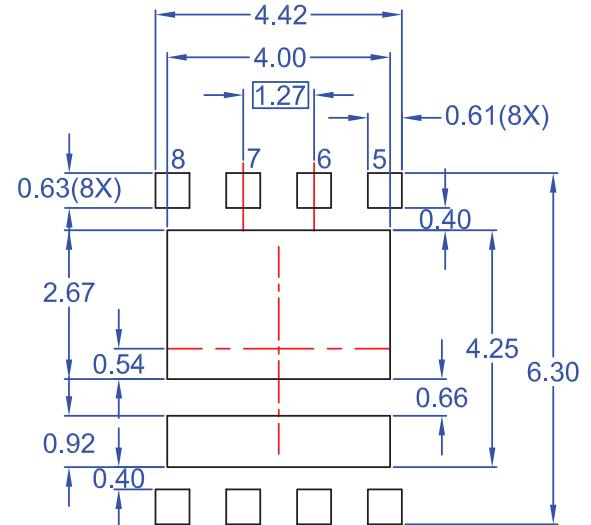
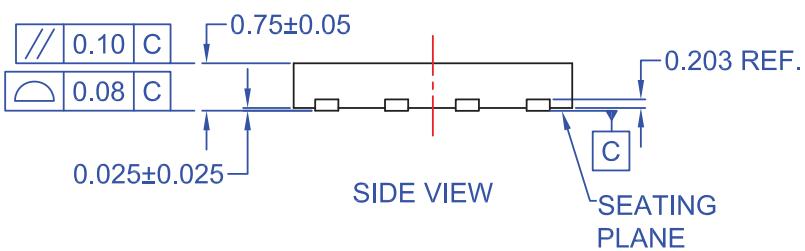
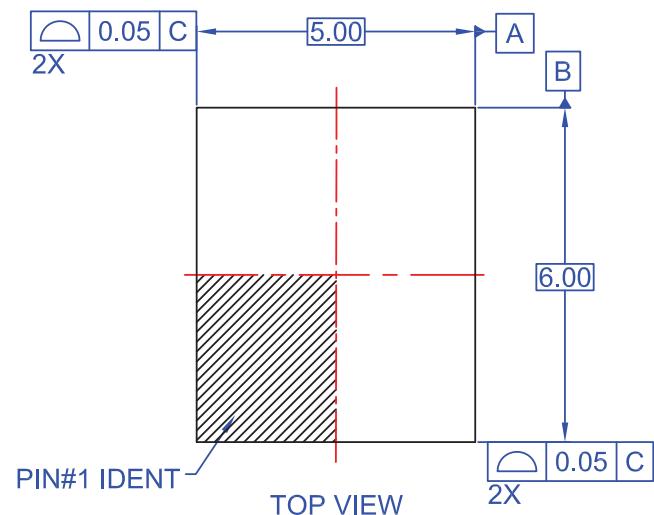


Figure 19. Capacitance vs Drain to Source Voltage



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